

Related Applications:

This application is a continuation of Serial No. 09/970,121 filed October 2, 2001 by Collins et al. now U.S. Patent No. 6,736,931, herein incorporated by reference, which is a divisional of Serial No. 09/675,319 filed September 29, 2000 by Kenneth S. Collins et al., herein incorporated by reference, which is a divisional of Serial No. 08/648,254 filed on May 13, 1996 by Kenneth S. Collins et al., herein incorporated by reference, which is a continuation-in-part of the following co-pending U.S. applications, the disclosures of which are incorporated herein by reference:

(a) Serial No. 08/580,026 filed December 20, 1995 by Kenneth S. Collins et al. which is a continuation of Serial No. 08/041,796 filed April 1, 1993 by Kenneth S. Collins et al. now U.S. Pat. No. 5,556,501 issued Sep. 17, 1996, which is a continuation of Serial No. 07/7[[7]]22,340 filed June 27, 1991 now abandoned;

(b) Serial No. 08/503,467 filed July 18, 1995 by Michael Rice et al. which is a divisional of Serial No. 08/138,060 filed October 15, 1993, U.S. Pat. No. 5,477,975 issued Dec. 26, 1995; and

(c) Serial No. 08/597,577 filed February 2, 1996 by Kenneth Collins, issued as U.S. Pat. No. 6,077,384 on Jun. 20, 2000, which is a continuation-in-part of Serial No. 08/521,668 filed August 31, 1995 (now abandoned), which is a continuation-in-part of Serial No. 08/289,336 filed August 11, 1994, which is a continuation of Serial No. 07/984,045 filed December 1, 1992 (now abandoned). In addition, U.S. application Serial No. 08/648,256 filed May 13, 1996 by Kenneth S. Collins et al. entitled "Plasma Reactor With Heated Source of a Polymer-Hardening Precursor Material" discloses related subject matter.